

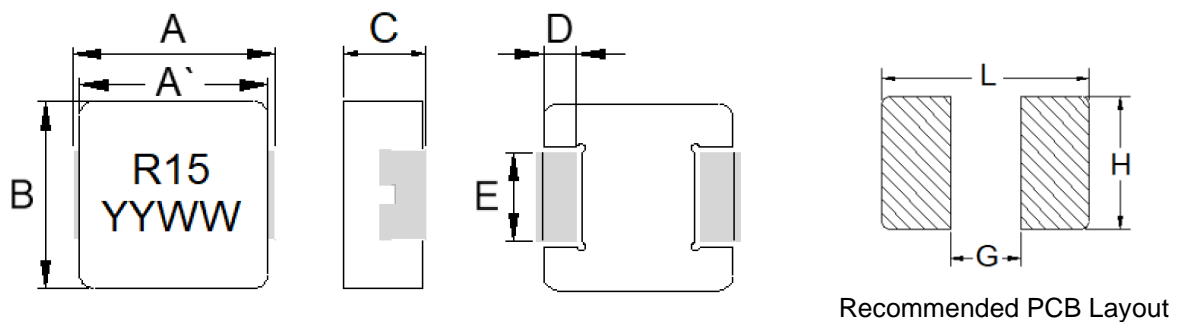
1. Part No. Expression

PIA 0 6 0 5 S R 1 5 M N

(a) (b) (c) (d) (e) (f)

- | | |
|--------------------|---------------------|
| (a) Series Code | (d) Inductance Code |
| (b) Dimension Code | (e) Tolerance Code |
| (c) Material Code | (f) Special Code |

2. Configuration & Dimensions (Unit: mm)

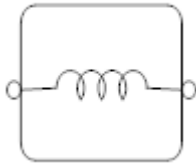


- Note:
1. The above PCB layout reference only.
 2. Recommend solder paste thickness at 0.15 mm and above.
 3. Marking: Top= Inductance Code, Bottom=YYWW (Year/World week), Black

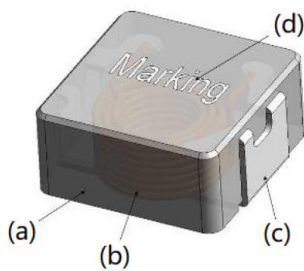
| A | A' | B | C | D |
|---------|---------|---------|---------|---------|
| 7.3±0.3 | 6.7±0.2 | 6.6±0.3 | 4.8±0.2 | 1.6±0.3 |
| E | L | G | H | - |
| 3.0±0.2 | 8.0 Ref | 3.5 Ref | 3.4 Ref | - |

NOTE: Specifications subject to change without notice. Please check our website for latest information.

3. Schematic



4. Material List



- (a) Core
- (b) Wire
- (c) Terminal
- (d) Ink

5. General Specifications

- (a) Operating Temp.: - 40°C to + 125°C (including self-temperature rise)
- (b) Storage Temp.: - 40°C to + 125°C (on board)
- (c) All test data referenced to 25°C ambient.
- (d) Heat Rated Current (I_{rms}) will cause the coil temperature rise approximately ΔT of 40°C.
- (e) Saturation Current (I_{sat}) will cause inductance L_0 to drop approximately 30%.
- (f) Rated DC Current: The lower value of I_{rms} and I_{sat} .
- (g) Part Temperature (Ambient + Temp. Rise): Should not exceed 125°C under worst case operating conditions.
- (h) Maximum Operating Voltage: 50V
- (i) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH

NOTE: Specifications subject to change without notice. Please check our website for latest information.

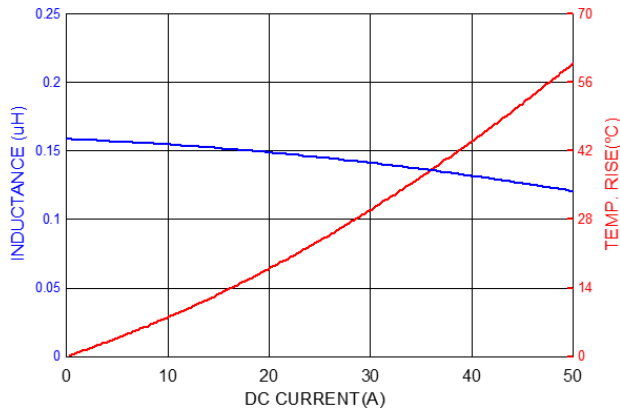
6. Electrical Characteristics

| Part Number | Inductance (μ H) @0A $\pm 20\%$ | Test Frequency | Irms (A) | | Isat (A) | | DCR (m Ω) | |
|---------------|--|-------------------|-------------|------|-------------|------|----------------------|------|
| | | | Typ | Max | Typ | Max | Typ | Max |
| PIA0605SR15MN | 0.15 | 1.0V/100KHz | 35.0 | 32.0 | 45.0 | 40.0 | 1.3 | 1.7 |
| PIA0605SR47MN | 0.47 | 1.0V/100KHz | 22.0 | 20.0 | 22.0 | 20.0 | 2.9 | 3.3 |
| PIA0605SR56MN | 0.56 | 1.0V/100KHz | 21.0 | 19.0 | 21.0 | 18.0 | 3.4 | 3.9 |
| PIA0605SR68MN | 0.68 | 1.0V/100KHz | 20.0 | 18.0 | 20.0 | 17.0 | 3.6 | 4.1 |
| PIA0605SR82MN | 0.82 | 1.0V/100KHz | 18.0 | 16.0 | 18.0 | 15.0 | 5.3 | 5.9 |
| PIA0605S1R0MN | 1.00 | 1.0V/100KHz | 17.0 | 15.0 | 16.0 | 13.0 | 5.6 | 6.2 |
| PIA0605S1R2MN | 1.20 | 1.0V/100KHz | 16.0 | 14.0 | 14.0 | 11.0 | 6.4 | 7.1 |
| PIA0605S1R5MN | 1.50 | 1.0V/100KHz | 15.0 | 13.0 | 13.0 | 10.5 | 6.6 | 7.3 |
| PIA0605S1R8MN | 1.80 | 1.0V/100KHz | 14.5 | 12.5 | 11.0 | 9.0 | 7.6 | 9.0 |
| PIA0605S2R2MN | 2.20 | 1.0V/100KHz | 14.0 | 12.0 | 10.0 | 8.5 | 10.0 | 11.5 |
| PIA0605S3R3MN | 3.30 | 1.0V/100KHz | 13.0 | 11.0 | 9.5 | 8.0 | 14.0 | 16.2 |
| PIA0605S4R7MN | 4.70 | 1.0V/100KHz | 11.0 | 9.5 | 8.8 | 7.5 | 20.8 | 24.0 |
| PIA0605S5R6MN | 5.60 | 1.0V/100KHz | 10.0 | 8.5 | 8.0 | 7.2 | 28.0 | 33.0 |
| PIA0605S6R8MN | 6.80 | 1.0V/100KHz | 9.0 | 8.0 | 7.6 | 7.0 | 30.0 | 36.0 |
| PIA0605S8R2MN | 8.20 | 1.0V/100KHz | 7.5 | 6.5 | 6.5 | 6.0 | 38.5 | 45.0 |
| PIA0605S100MN | 10.0 | 1.0V/100KHz | 7.0 | 6.0 | 6.0 | 5.7 | 44.0 | 53.0 |
| PIA0605S120MN | 12.0 | 1.0V/100KHz | 5.8 | 4.8 | 5.1 | 4.7 | 56.0 | 68.0 |
| PIA0605S150MN | 15.0 | 1.0V/100KHz | 5.0 | 4.0 | 4.0 | 3.2 | 73.0 | 85.0 |
| PIA0605S220MN | 22.0 | 1.0V/100KHz | 4.2 | 3.6 | 3.6 | 3.1 | 122 | 142 |
| PIA0605S330MN | 33.0 | 1.0V/100KHz | 3.0 | 2.5 | 2.3 | 1.8 | 142 | 170 |
| PIA0605S470MN | 47.0 | 1.0V/100KHz | 2.6 | 2.0 | 1.8 | 1.5 | 275 | 320 |

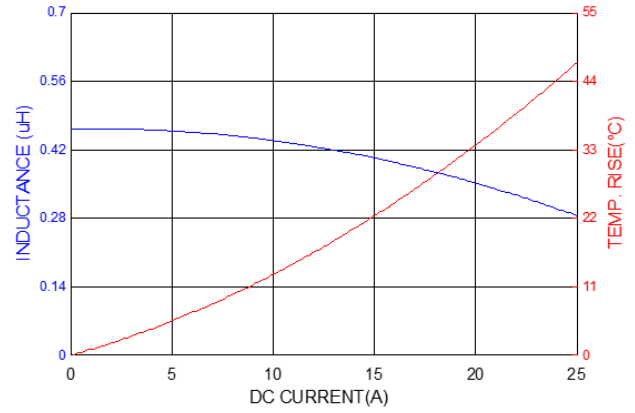
NOTE: Specifications subject to change without notice. Please check our website for latest information.

7. Characteristics Curve

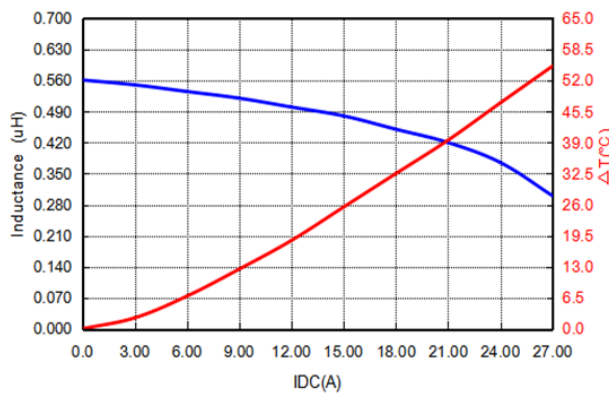
PIA0605SR15MN



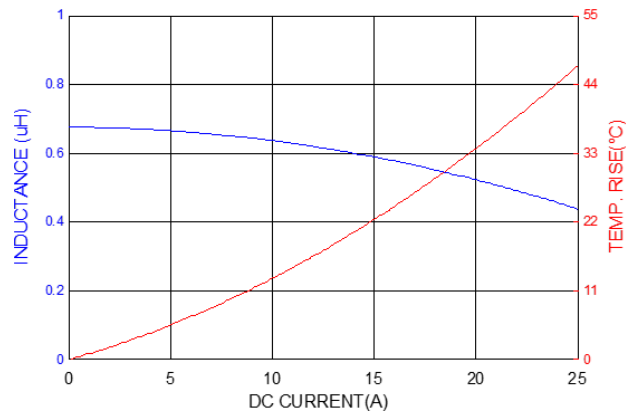
PIA0605SR47MN



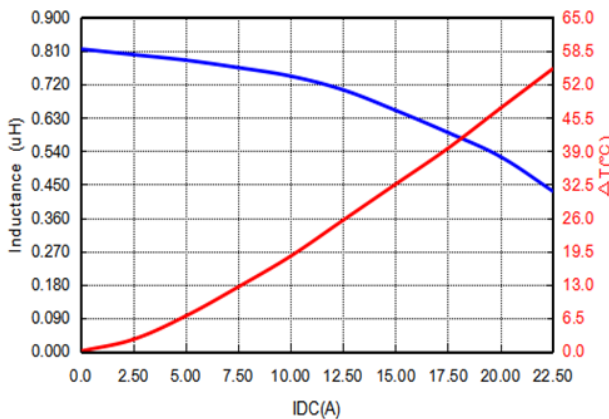
PIA0605SR56MN



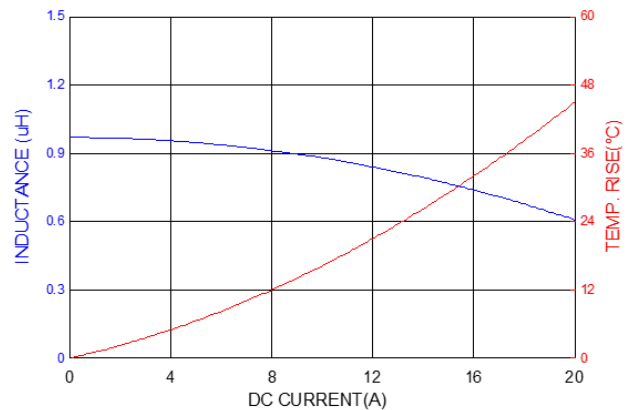
PIA0605SR68MN



PIA0605SR82MN

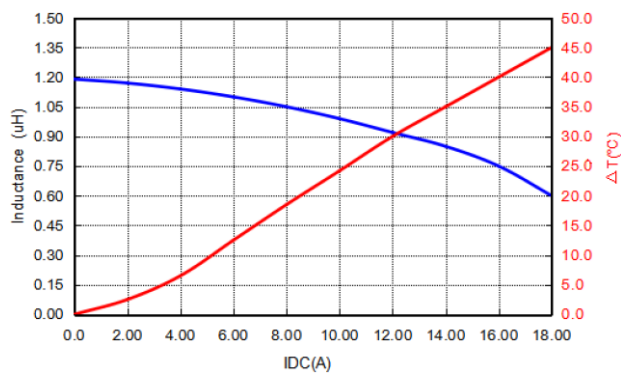


PIA0605S1R0MN

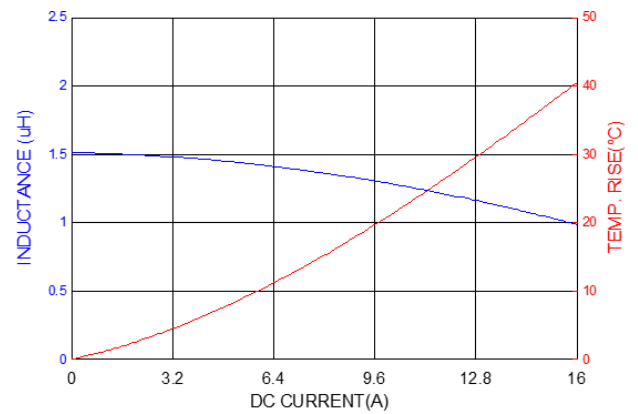


NOTE: Specifications subject to change without notice. Please check our website for latest information.

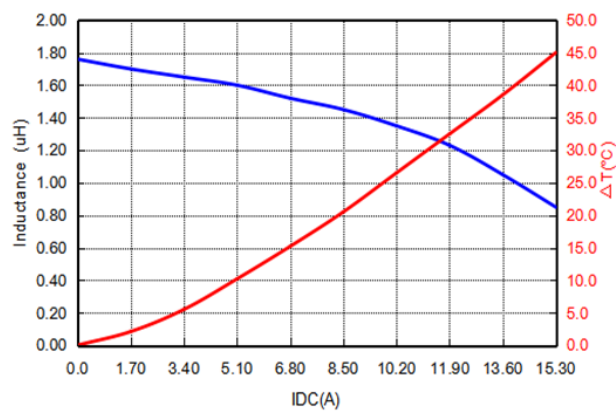
PIA0605S1R2MN



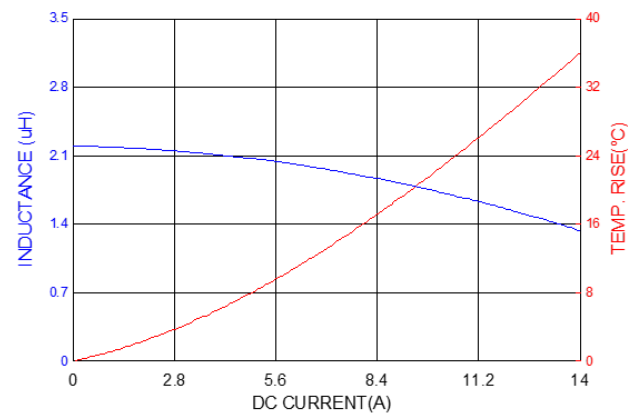
PIA0605S1R5MN



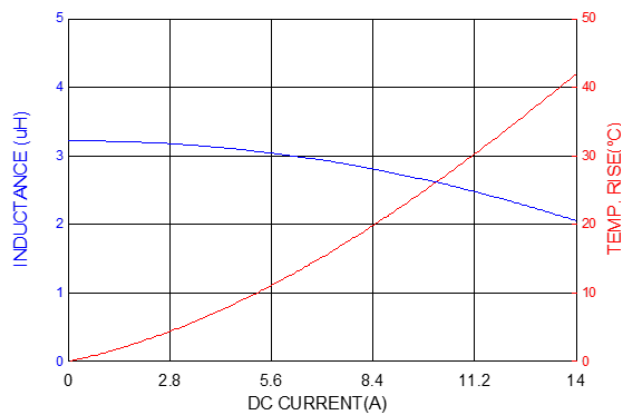
PIA0605S1R8MN



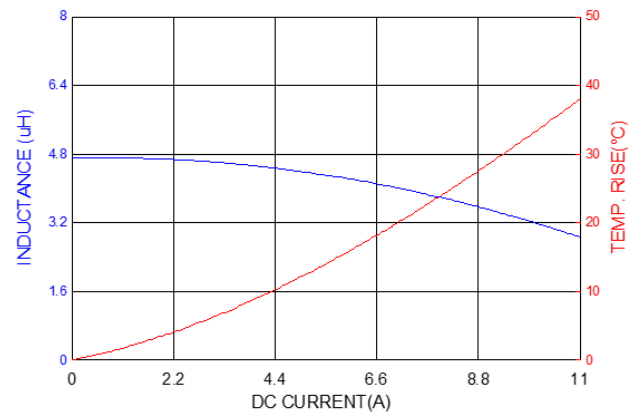
PIA0605S2R2MN



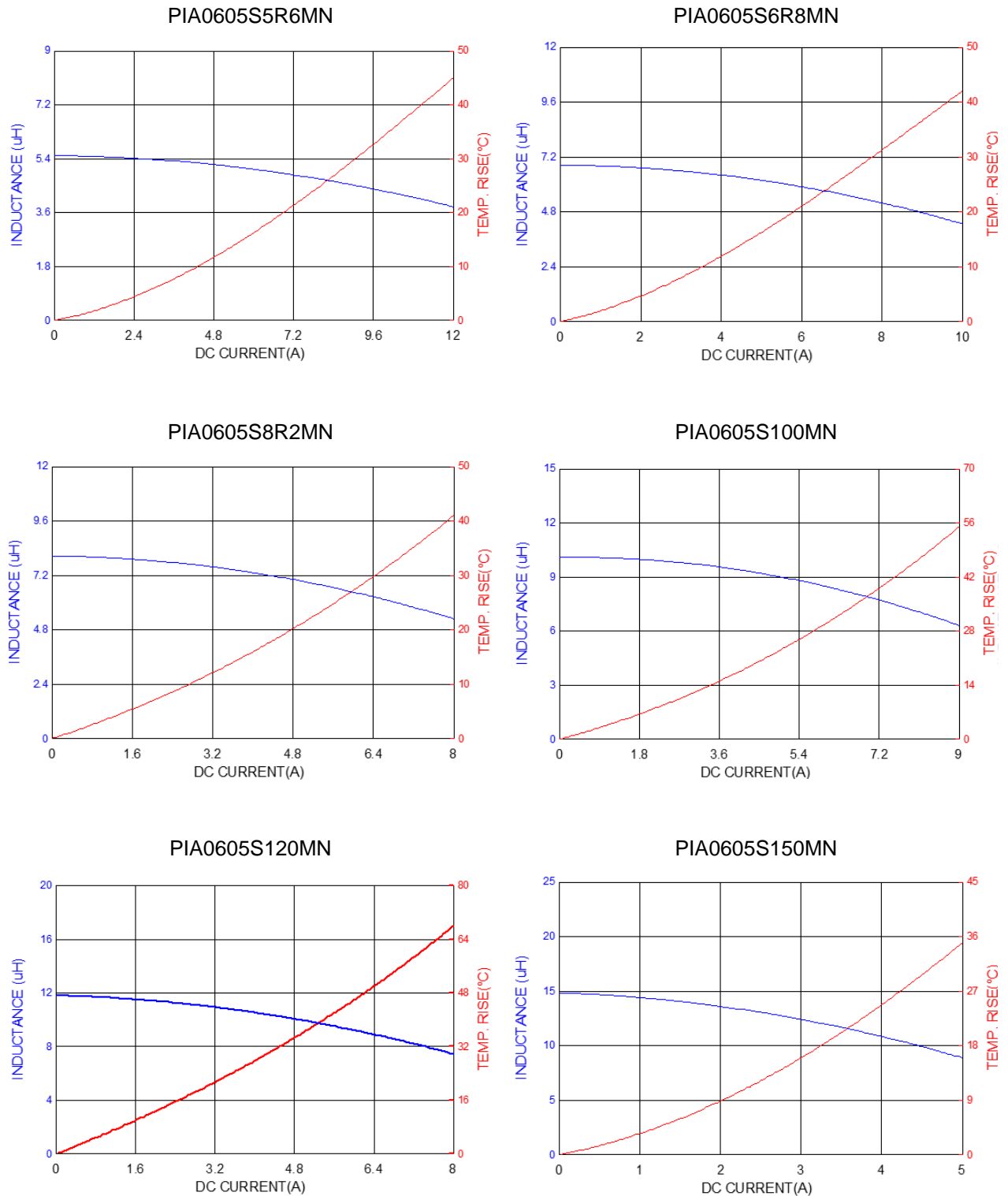
PIA0605S3R3MN



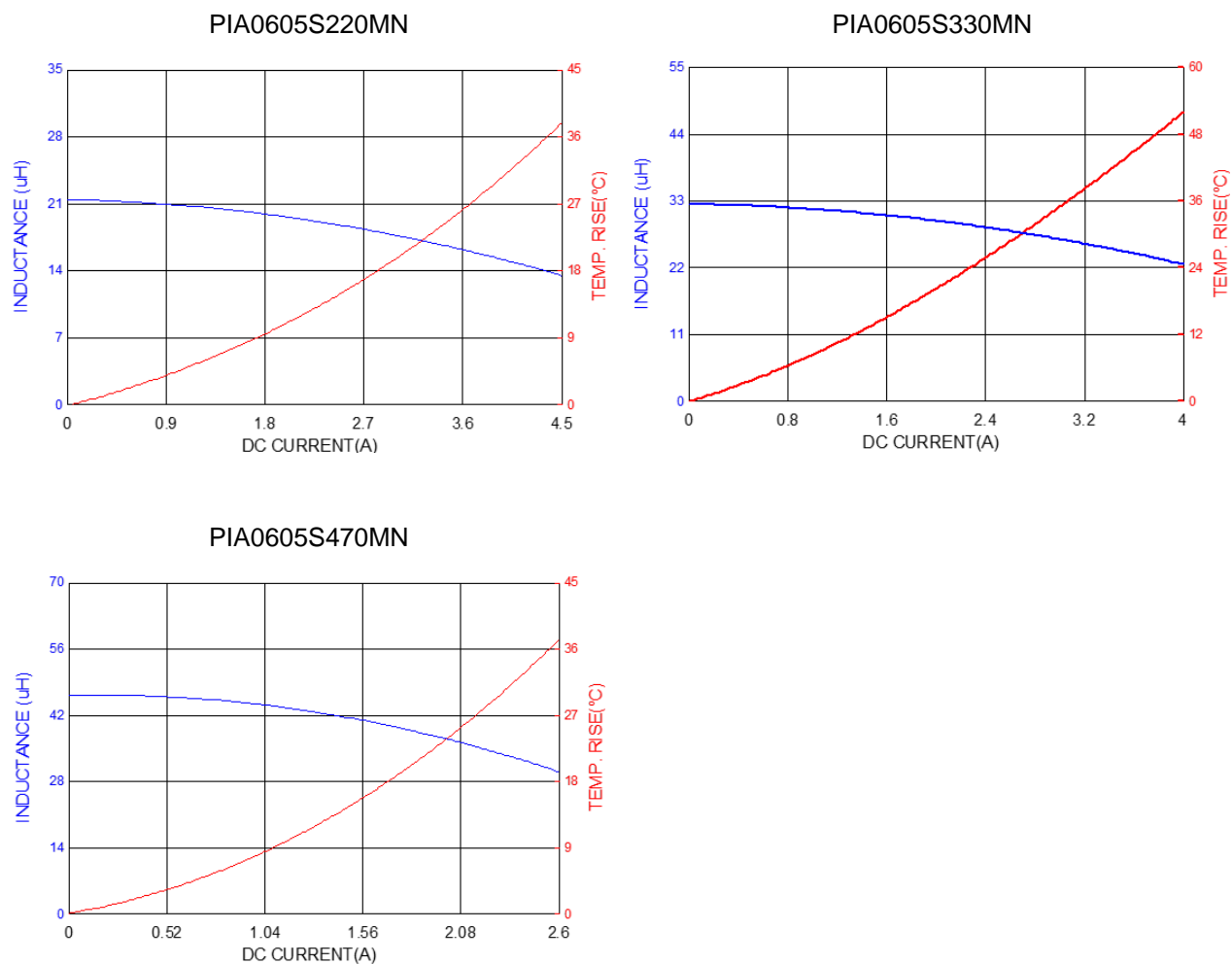
PIA0605S4R7MN



NOTE: Specifications subject to change without notice. Please check our website for latest information.



NOTE: Specifications subject to change without notice. Please check our website for latest information.



NOTE: Specifications subject to change without notice. Please check our website for latest information.

8. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1. IR Soldering Reflow

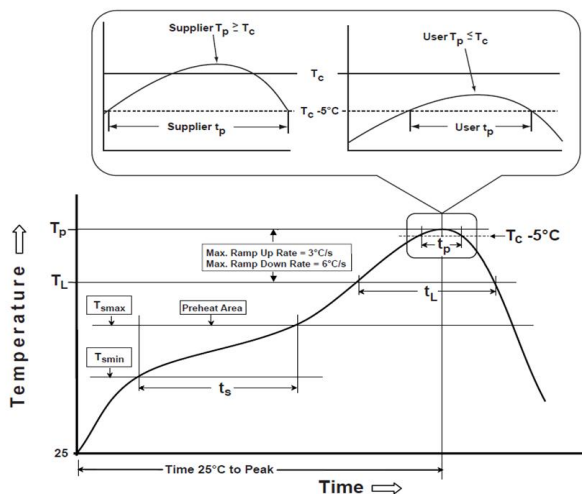
Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

8-2. Iron Reflow

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

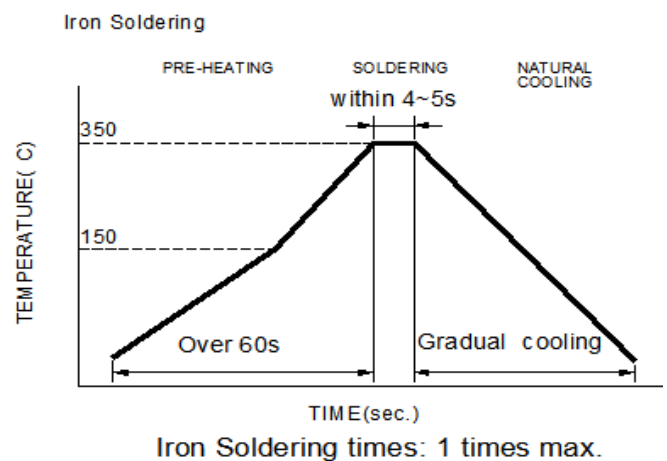
Note:

- Preheat circuit and products to 150°C.
- 355°C tip temperature (Max.)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (Max.)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 4~5 sec.



Reflow times: 3 times Max

Figure 1: IR Soldering Reflow



Soldering iron method: 350±5°C Max

Figure 2: Iron soldering temperature profiles

NOTE: Specifications subject to change without notice. Please check our website for latest information.

Table (1.1) Reflow Profiles

| | |
|--|------------------|
| Profile Type: | Pb-Free Assembly |
| Preheat | |
| -Temperature Min (T_{smin}) | 150°C |
| -Temperature Max (T_{smax}) | 200°C |
| -Time (t_s) from (T_{smin} to T_{smax}) | 60-120seconds |
| Ramp-up rate (T_L to T_p) | 3°C /second max. |
| Liquids temperature (T_L) | 217°C |
| Time (t_L) maintained above T_L | 60-150 seconds |
| Classification temperature (T_c) | See Table (1.2) |
| Time (t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .) | * < 30 seconds |
| Ramp-down rate (T_p to T_L) | 6°C /second max. |
| Time 25°C to peak temperature | 8 minutes max. |

T_p : maximum peak package body temperature, **T_c** : the classification temperature.

For user (customer) **T_p** should be equal to or less than **T_c** .

*Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

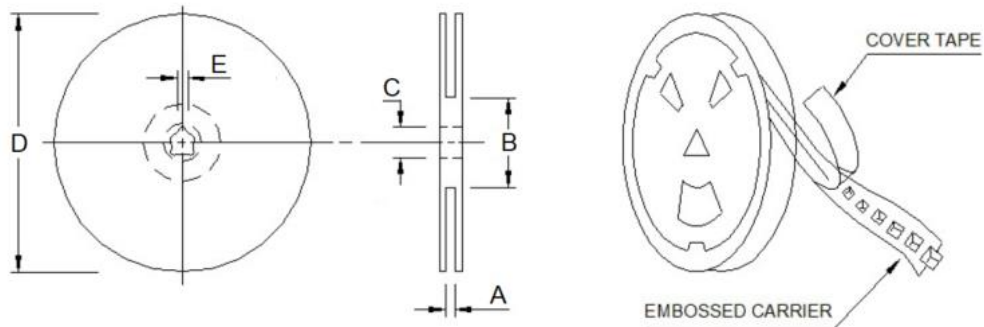
| | Package Thickness | Volume mm ³ <350 | Volume mm ³ 350-2000 | Volume mm ³ >2000 |
|------------------|-------------------|-----------------------------|---------------------------------|------------------------------|
| PB-Free Assembly | <1.6mm | 260°C | 260°C | 260°C |
| | 1.6-2.5mm | 260°C | 250°C | 245°C |
| | ≥2.5mm | 250°C | 245°C | 245°C |

Reflow is referred to standard IPC/JEDEC J-STD-020E.

NOTE: Specifications subject to change without notice. Please check our website for latest information.

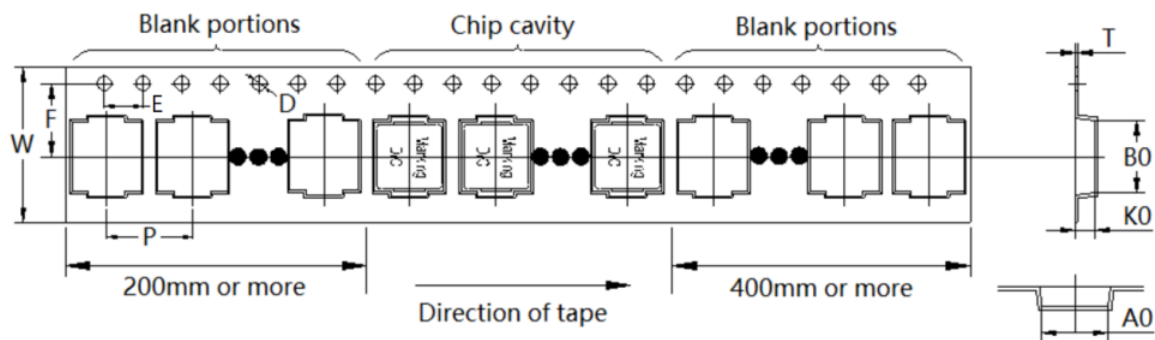
9. Packaging Information

9-1. Reel Dimension (Unit: mm)



| Type | A | B | C | D | E |
|----------|---------------|-----------|---------------|-------|---------|
| 13"x16mm | 16.4+2.0/-0.0 | 100.0±2.0 | 13.0+0.5/-0.2 | 330.0 | 2.0±0.5 |

9-2. Tape Dimension (Unit: mm)



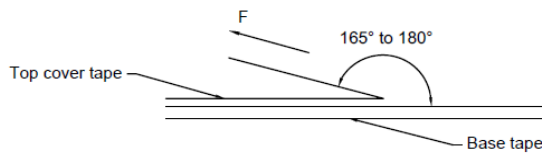
| B0 | A0 | K0 | P | W |
|-----------|-----------|-----------|------------|------------|
| 7.70±0.10 | 7.00±0.10 | 5.30±0.10 | 12.00±0.10 | 16.00±0.30 |
| F | T | D | E | - |
| 7.50±0.10 | 0.35±0.05 | 1.50±0.10 | 4.00 | - |

NOTE: Specifications subject to change without notice. Please check our website for latest information.

9-3. Packaging Quantity (Unit: Pcs)

| | |
|------------|-------|
| Chip/ Reel | 800 |
| Inner box | 1,600 |
| Carton | 6,400 |

9-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

| Room Temp. (°C) | Room Humidity (%) | Room atm (hPa) | Tearing Speed (mm/min) |
|-----------------|-------------------|----------------|------------------------|
| 5~35 | 45~85 | 860~1060 | 300±10 |

| Tape Size | 8 mm | 12 to 56 mm | 72 mm or Wider |
|---------------------------|--------|-------------|----------------|
| Tearing Off Force (grams) | 10~100 | 10~130 | 10~150 |

Application Notice

1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

NOTE: Specifications subject to change without notice. Please check our website for latest information.